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Docket No.: 4448-0173PUS1
(PATENT)

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Chen-Jung TSAI et al.

Application No.: 10/726,577

Confirmation No.: 5109

Filed: December 4, 2003

Art Unit: 2815

For: Dual chips stacked packaging structure

Examiner: J. A. Fenty

REPLY TO NOTICE OF NON-COMPLIANT AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Responsive to the March 14, 2006 Notice of Non-Compliant Amendment, attached hereto is a corrected version of the "claims" section of the Preliminary Amendment submitted on February 22, 2006.

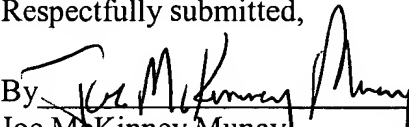
Although the Notice of Non-Compliant Amendment specifically noted that claims 21-23 lacked status identifiers, it is noted that this is not the case as these claims were newly presented and were properly identified as "(New)." It is noted, however, that claims amended in the February 22, 2006 Preliminary Amendment were not marked-up properly, and that the newly presented claims were presented as marked-up claims instead of "clean" claims. Accordingly, these informalities have also been corrected in the attached corrected version of the "claims" section of the February 22, 2006 Preliminary Amendment. It is therefore respectfully submitted that all claims are marked with the proper status identifier

The present submission is being timely filed within thirty (30) days of the mailing date of the Notice. Accordingly, no extension of time fees should be due.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. §§ 1.16 or 1.17; particularly, extension of time fees.

Dated: April 14, 2006

Respectfully submitted,

By 

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